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## Si4420DY\*

# Single N-Channel Logic Level PowerTrench $^{\circledR}$ MOSFET

### **General Description**

This N-Channel Logic Level MOSFET is produced using Fairchild Semiconductor's advanced PowerTrench process that has been especially tailored to minimize on-state resistance and yet maintain superior switching performance.

This device is well suited for low voltage and battery powered applications where low in-line power loss and fast switching are required.

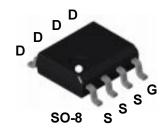
### **Applications**

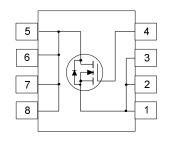
- · Battery switch
- · Load switch
- Motor controls

### **Features**

• 12.5 A, 30 V. 
$$R_{DS(ON)}$$
 = 0.009  $\Omega$  @  $V_{GS}$  = 10 V 
$$R_{DS(ON)}$$
 = 0.013  $\Omega$  @  $V_{GS}$  = 4.5 V

- · Low gate charge.
- · Fast switching speed.
- High performance trench technology for extremely low  $R_{_{\mathrm{DS(ON)}}}.$
- · High power and current handling capability.





Absolute Maximum Ratings T<sub>A</sub> = 25°C unless otherwise noted

| Symbol                            | Parameter  |           | Ratings     | Units |  |
|-----------------------------------|--|-----------|-------------|-------|--|
| V <sub>DSS</sub>                  | Drain-Source Voltage                             |           | 30          | V     |  |
| V <sub>GSS</sub>                  | Gate-Source Voltage                              |           | <u>+</u> 20 | V     |  |
| I <sub>D</sub>                    | Drain Current - Continuous                       | (Note 1a) | 12.5        | А     |  |
|                                   | - Pulsed   |           | 50          |       |  |
| P <sub>D</sub>                    | Power Dissipation for Single Operation           | (Note 1a) | 2.5         | W     |  |
|                                   |  | (Note 1b) | 1.2         |       |  |
|                                   |  | (Note 1c) | 1           |       |  |
| T <sub>J</sub> , T <sub>STG</sub> | Operating and Storage Junction Temperature Range |           | -55 to +150 | ∘C    |  |

### **Thermal Characteristics**

| R <sub>e JA</sub> | Thermal Resistance, Junction-to-Ambient | (Note 1a) | 50 | ∘C/W |
|-------------------|---|-----------|----|------|
| R <sub>a JC</sub> | Thermal Resistance, Junction-to-Case    | (Note 1)  | 25 | ∘C/W |

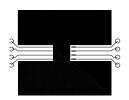
Package Outlines and Ordering Information

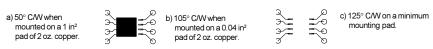
| Device Marking | Device   | Reel Size | Tape Width | Quantity   |
|----------------|----------|-----------|------------|------------|
| 4420           | SI4420DY | 13"       | 12mm       | 2500 units |

<sup>\*</sup> Die and manufacturing source subject to change without prior notification.

| Off Char<br>BV <sub>DSS</sub>       |   | Test Conditions  | Min | Тур  | Max            | Units |
|-------------------------------------|---|--|-----|------|----------------|-------|
| BV <sub>DSS</sub>                   | acteristics                                       |  |     |      |                |       |
|                                     | Drain-Source Breakdown<br>Voltage                 | $V_{GS} = 0 V, I_{D} = 250 \mu A$  | 30  |      |                | V     |
| <u>∆BV⊳ss</u><br>∆T,,               | Breakdown Voltage<br>Temperature Coefficient      | I <sub>D</sub> = 250 μA, Referenced to 25°C  |     | 33   |                | mV/°C |
| I <sub>DSS</sub>                    | Zero Gate Voltage Drain<br>Current                | $V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}$<br>$V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55^{\circ}\text{C}$ |     |      | 1<br>5         | μА    |
| I <sub>GSSF</sub>                   | Gate-Body Leakage Current,<br>Forward             | V <sub>GS</sub> = 20 V, V <sub>DS</sub> = 0 V  |     |      | 100            | nA    |
| I <sub>GSSR</sub>                   | Gate-Body Leakage Current,<br>Reverse             | V <sub>GS</sub> = -20 V, V <sub>DS</sub> = 0 V   |     |      | -100           | nA    |
| On Char                             | racteristics (Note 2)                             |  |     |      |                |       |
| $V_{GS(th)}$                        | Gate Threshold Voltage                            | V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = 250 μA  | 1.0 |      |                | V     |
| $\Delta V_{GS(th)} = \Delta T_{.l}$ | Gate Threshold Voltage<br>Temperature Coefficient | I <sub>D</sub> = 250 μA,Referenced to 25°C   |     | -4.5 |                | mV/°C |
| R <sub>DS(on)</sub>                 | Static Drain-Source<br>On-Resistance              | $V_{GS} = 10 \text{ V}, I_D = 12.5 \text{ A}$<br>$V_{GS} = 4.5 \text{ V}, I_D = 10.5 \text{ A}$                            |     |      | 0.009<br>0.013 | Ω     |
| I <sub>D(on)</sub>                  | On-State Drain Current                            | V <sub>GS</sub> = 10 V, V <sub>DS</sub> = 5 V  | 30  |      |                | Α     |
| <b>g</b> <sub>FS</sub>              | Forward Transconductance                          | V <sub>DS</sub> = 15 V, I <sub>D</sub> = 12.5 A  |     | 35   |                | S     |
| Dynami                              | c Characteristics                                 |  |     |      | •              | •     |
| C <sub>iss</sub>                    | Input Capacitance                                 | V <sub>DS</sub> = 15 V, V <sub>GS</sub> = 0 V,   |     | 2180 |                | pF    |
| Coss                                | Output Capacitance                                | f = 1.0 MHz  |     | 500  |                | pF    |
| C <sub>rss</sub>                    | Reverse Transfer<br>Capacitance                   |  |     | 255  |                | pF    |
| Switchir                            | ng Characteristics (Note 2                        | )  |     |      |                |       |
| $t_{d(on)}$                         | Turn-On Delay Time                                | $V_{DD} = 15 \text{ V}, I_D = 1 \text{ A}, R_L = 15 \Omega$  |     | 13   | 25             | ns    |
| t <sub>r</sub>                      | Turn-On Rise Time                                 | $V_{GS}$ = 10 V, $R_{GEN}$ = 6 $\Omega$  |     | 14   | 25             | ns    |
| t <sub>d (off)</sub>                | Turn-Off Delay Time                               |  |     | 43   | 200            | ns    |
| t <sub>f</sub>                      | Turn-Off Fall Time                                |  |     | 15   | 70             | ns    |
| t <sub>rr</sub>                     | Drain-Source Reverse<br>Recovery Time             | $I_F = 2.3 \text{ A}, \text{ di/dt} = 100 \text{A}/\mu \text{s}$   |     |      | 90             | nS    |
| $Q_g$                               | Total Gate Charge                                 | V <sub>DS</sub> = 15 V, I <sub>D</sub> = 12.5 A,   |     | 23   | 53             | nC    |
| $Q_{gs}$                            | Gate-Source Charge                                | V <sub>GS</sub> = 5 V  |     | 7    |                | nC    |
| $Q_{gd}$                            | Gate-Drain Charge                                 |  |     | 11   |                | nC    |
| Drain-Sc                            | ource Diode Characteris                           | tics and Maximum Ratings   |     |      |                |       |
| <u>Бтапт-50</u><br>I <sub>s</sub>   | Maximum Continuous Drain-S                        | <u> </u>   |     |      | 2.3            | А     |
| V <sub>SD</sub>                     | Drain-Source Diode Forward<br>Voltage             | V <sub>GS</sub> = 0 V, I <sub>S</sub> = 2.3 A (Note 2)   |     | 0.72 | 1.1            | V     |

<sup>1:</sup>  $R_{0,0,4}$  is the sum of the junction-to-case and case-to-ambient resistance where the case thermal reference is defined as the solder mounting surface of the drain pins.  $R_{\theta JC}$  is guaranteed by design while  $R_{\theta CA}$  is determined by the user's board design.







Scale 1 : 1 on letter size paper 2: Pulse Test: Pulse Width  $\leq$  300  $\mu s,$  Duty Cycle  $\leq$  2.0%

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